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# User Guide for FEBFSB127H\_T001 Evaluation Board

# FSB127H 100 kHz Power Switch for ATX Standby 16 W

Featured Fairchild Product:

FSB127H

Direct questions or comments about this Evaluation Board to: "Worldwide Direct Support"

Fairchild Semiconductor.com





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This user guide supports the 16 W evaluation board for ATX standby using FSB127H. It should be used in conjunction with the FSB127H datasheet as well as Fairchild's application notes and technical support team. Please visit Fairchild's website at www.fairchildsemi.com.

## 1. Overview

The highly integrated FSB-series consists of an integrated Current Mode Pulse Width Modulator (PWM) and an avalanche-rugged 700 V SenseFET. It is specifically designed for high-performance offline Switch Mode Power Supplies (SMPS) with minimal external components.

Compared with a discrete MOSFET and controller or RCC switching converter solution, the FSB-series reduces total component count, design size, and weight while increasing efficiency, productivity, and system reliability. These devices provide a basic platform for the design of cost-effective flyback converters, as in PC auxiliary power supplies.



Figure 1. Photo of FEBFSB127H\_T001

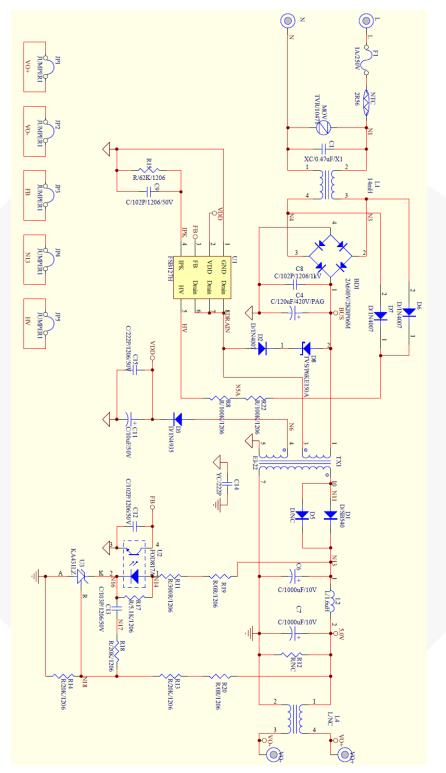
# 2. Board Configuration

- Input Voltage:  $90 V_{AC} 264 V_{AC}$
- Output Voltage: 5 V
- Output Current: 0 3.2 A
- Operation Frequency: 100 kHz





# 3. Schematic









# 4. PCB Layout

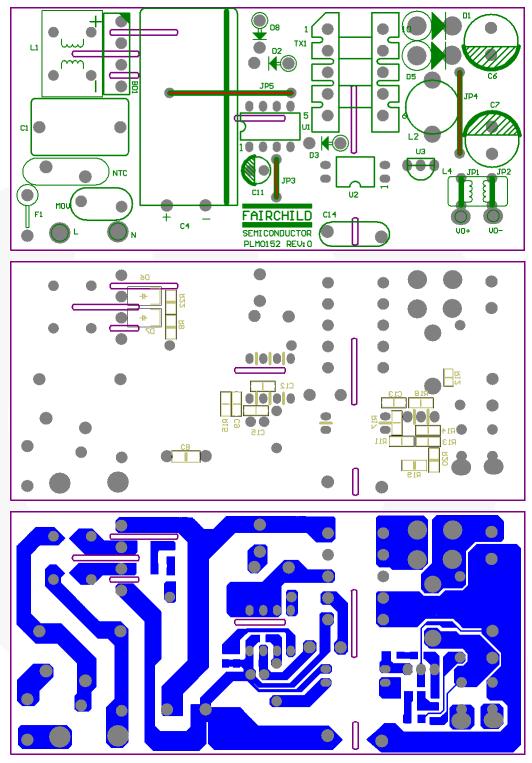


Figure 3. Evaluation Board PCB Layout





# 5. Test Results

#### 5.1. Brown-in / Brownout

#### 5.1.1. Test Condition

Decrease input AC voltage gradually and measure the turn-off threshold.

After AC power off, increase input voltage and measure the recovery threshold.

#### 5.1.2. Test Result

R <sub>Hv</sub> =200 kΩ	Minimum Load	Maximum Load		
Turn off	70 V <sub>AC</sub>	68 V <sub>AC</sub>		
Turn on	81 V <sub>AC</sub>	81 V <sub>AC</sub>		

## 5.2. AC Trim Up and Trim Down

#### 5.2.1. Test Condition

Switch the input voltage from 90  $V_{AC}$  to 264  $V_{AC}$  or from 264  $V_{AC}$  to 90  $V_{AC}$ ; the output voltages should be normal.

#### 5.2.2. Test Result

	Minimum Load Maximum Load	
90 V <sub>AC</sub> → 264 V <sub>AC</sub>	Pass	Pass
$264 \text{ V}_{\text{AC}} \rightarrow 90 \text{ V}_{\text{AC}}$	Pass	Pass

## 5.3. Line and Load Regulation

#### 5.3.1. Test Condition

Line regulation: 1% maximum.

Load regulation: 5% maximum.

#### 5.3.2. Test Result

Input Voltage	Max. Load	Min. Load	Load Regulation (%)
90 V <sub>AC</sub> / 60 Hz	4.971 V	5.013 V	0.84%
264 V <sub>AC</sub> / 50 Hz	4.988 V	5.013 V	0.04 %
Line Regulation (%)	0.34%	0%	

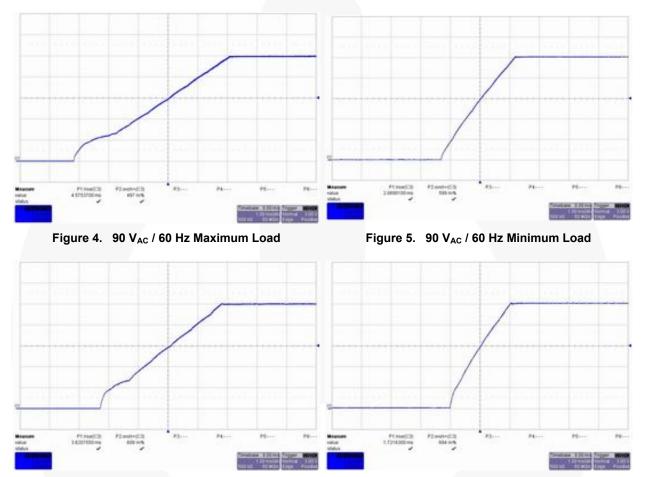




# 5.4. DC Output Rise Time

#### 5.4.1. Test Condition

Load: maximum load and minimum load. DC-output rise time: 20 ms, maximum.



#### 5.4.2. Measured Waveforms

Figure 6. 264 V<sub>AC</sub> / 50 Hz Maximum Load

Figure 7. 264 V<sub>AC</sub> / 50 Hz Minimum Load

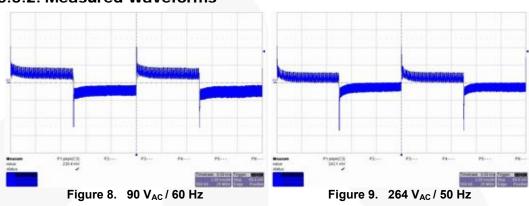




## 5.5. DC Transient Response

#### 5.5.1. Test Condition

From 10% to 90% of the maximum load, with a 2.5 A/ $\mu$ s slew rate. Output load frequency is 100 Hz with 50% duty cycle.



### 5.5.2. Measured Waveforms

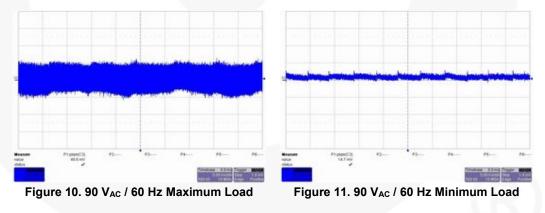
#### 5.6. Ripple and Noise

#### 5.6.1. Test Condition

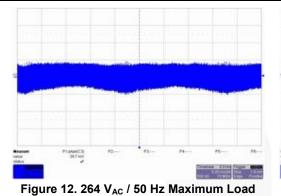
Ripple and noise are measured using a 20 MHz bandwidth-limited oscilloscope with a 10  $\mu$ F electrolytic capacitor paralleled with a high-frequency 0.1  $\mu$ F ceramic across each output.

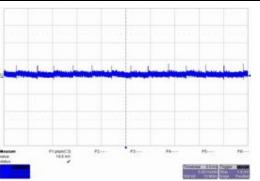
#### 5.6.2. Measured Waveform

Ripple and noise are measured using a 20 MHz bandwidth-limited oscilloscope with a 10  $\mu$ F electrolytic capacitor paralleled with a high-frequency 0.1  $\mu$ F ceramic across each output.









ww.fairchilds

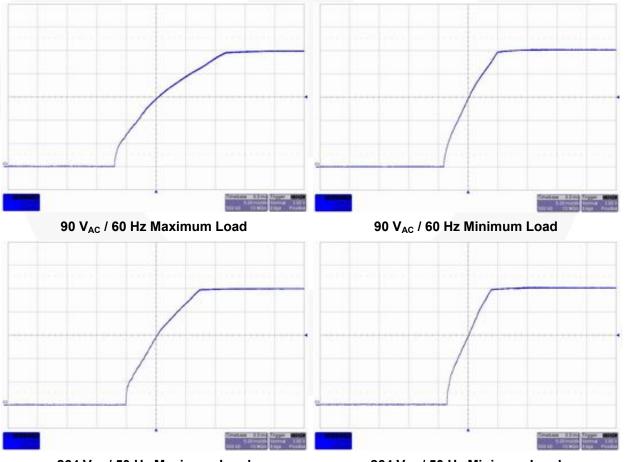
Figure 13. 264 V<sub>AC</sub> / 50 Hz Minimum Load

# 5.7. Capacitive Load

#### 5.7.1. Test Condition

Output Capacitive Load =  $12000 \ \mu F$ 

# 5.7.2. Measured Waveforms



264 V<sub>AC</sub> / 50 Hz Maximum Load

264 V<sub>AC</sub> / 50 Hz Minimum Load





### 5.8. Power Saving

#### 5.8.1. Test Condition

The input wattage is < 1 W in Standby Mode with 0.5 W loading for 2010 EuP. The input wattage is < 0.5 W in Standby Mode with 0.25 W loading for 2013 EuP.

#### 5.8.2. Test Result

	FSB127H	Input Watts	Output Watts
Α.	When $V_{IN}$ = 230 $V_{AC}$ , with 0.5 W Loading	0.713 W	0.5 W
	When $V_{IN}$ = 240 $V_{AC}$ , with 0.5 W Loading	0.715 W	0.5 W
	When $V_{IN}$ = 264 $V_{AC}$ , with 0.5 W Loading	0.733 W	0.5 W
В.	When $V_{IN}$ = 230 $V_{AC}$ , with 0.25 W Loading	0.384 W	0.25 W
	When $V_{IN}$ = 240 $V_{AC}$ , with 0.25 W Loading	0.389 W	0.25 W
	When $V_{IN}$ = 264 $V_{AC}$ , with 0.25 W Loading	0.406 W	0.25 W
C.	When $V_{IN}$ = 230 $V_{AC}$ , with No Loading	53 mW	x
	When $V_{IN}$ = 240 $V_{AC}$ , with No Loading	56 mW	x
	When $V_{IN}$ = 264 $V_{AC}$ , with No Loading	68 mW	x

## 5.9. Efficiency

#### 5.9.1. Test Condition

Measure efficiency at minimum, mid-point, and maximum loading.

#### 5.9.2. Test Result

FSB127H	Input Watts	Output Watts	Efficiency
When $V_{IN}$ = 115 $V_{AC}$ , at 100% Load	20.62 W	16 W	81.17%
When $V_{IN}$ = 115 $V_{AC}$ , at 75% Load	15.28 W	12 W	82.42%
When $V_{IN}$ = 115 $V_{AC}$ , at 50% Load	10.02 W	8 W	82.51%
When $V_{IN}$ = 115 $V_{AC}$ , at 25% Load	5.07 W	4 W	81.70%
When $V_{\text{IN}}\text{=}230~V_{\text{AC}}\text{,}$ at 100% Load	20.78 W	16 W	81.40%
When $V_{IN}$ = 230 $V_{AC}$ , at 75% Load	15.11 W	12 W	82.24%
When $V_{IN}$ = 230 $V_{AC}$ , at 50% Load	10.15 W	8 W	80.45%
When $V_{IN}$ = 230 $V_{AC}$ , at 25% Load	5.18 W	4 W	78.62%





# 5.10. Short-Circuit Protection

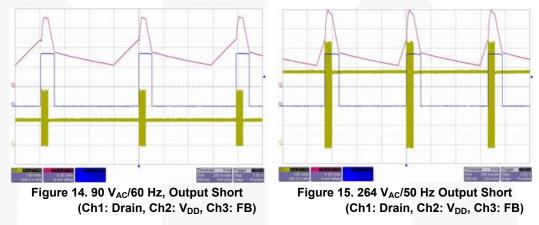
### 5.10.1. Test Condition

In the event of a short circuit on any DC output, the power supply should be protected from damage.

#### 5.10.2. Test Result

	90 V <sub>AC</sub> / 60 Hz	264 V <sub>AC</sub> / 50 Hz
Minimum Load	PASS	PASS
Maximum Load	PASS	PASS

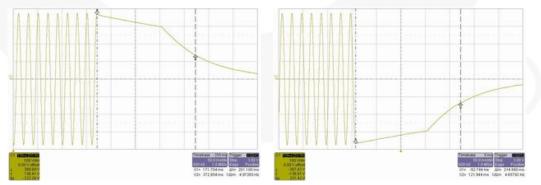
#### 5.10.3. Measured Waveforms



## 5.11. X-Cap Discharge

#### 5.11.1. Test Condition

The X-capacitor voltage should decay to less than 37% of its original peak value in one second after the AC input is disconnected.



#### 5.11.2. Measured Waveforms

Figure 16. 264 V\_{AC} / 50 Hz, No Load, X-Cap=0.47  $\mu\text{F},\,\text{R}_{\text{HV}}\text{=}200\ \text{k}\Omega$ 





## 5.12. Over-Power Protection

#### 5.12.1. Test Condition

An over-current from the output return line does not damage the power supply and the OLP protection is enabled.

#### 5.12.2. Test Result

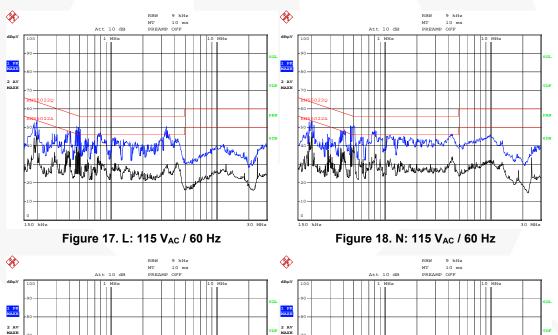
Input Voltage	90 V <sub>AC</sub>	115 V <sub>AC</sub>	132 V <sub>AC</sub>	180 V <sub>AC</sub>	230 V <sub>AC</sub>	264 V <sub>AC</sub>
OPP (W)	24.10 W	25.43 W	26.42 W	26.37 W	26.04 W	26.12 W

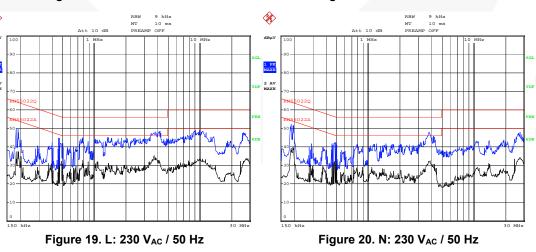
## 5.13. Surge and ESD

#### 5.13.1. Test Result

L-PE ±6 kV	N-PE ±6 kV	L-N ±1 kV	AIR ±16 kV	Contact ±8 kV
Pass	Pass	Pass	Pass	Pass

## 5.14. EMI Conduction





#### 5.14.1. Measured Waveforms





# 6. Bill of Materials

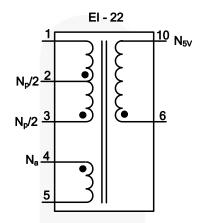
Component	Qty	Part No.	Manufacturer	Reference
JUMPER WIRE 0.8Ø (mm)	5			JP1, JP2, JP3, JP4, JP5
Resistor 1206 0 Ω ±5%	2			R19, R20
Resistor 1206 100 kΩ ±5%	2			R8, R22
Resistor 1206 20 kΩ ±1%	3			R13, R14, R18
Resistor 1206 300 Ω ±5%	1			R11
Resistor 1206 51 kΩ ±5%	1			R17
Resistor 1206 62 kΩ ±1%	1			R15
NTC 13Ø 2 ΩSCK132	1			NTC
1206 MLCC X7R 102P 50 V ±10%	2			C9, C12
1206 MLCC X7R 102P 1 kV ±10%	1			C8
1206 MLCC X7R 103P 50 V ±10%	1			C13
1206 MLCC X7R 222P 50 V ±10%	1			C15
Electrolytic Capacitor 10 µF 50 V 105°C	1	LHK	JACKCON	C11
Electrolytic Capacitor 120 µF 420 V 105°C	1	LHK	PAG	C4
Electrolytic Capacitor 1000 µF 10 V 105°C	2	LHK	SAMXON	C6, C7
X2 Capacitor 0.47 µF 275 V ±20%	1			C1
Y1 Capacitor 222P 250 V ±20%	1			C14
Inductor 14 mH	1	TRN0183	SEN HUEI	L1
Inductor 2.5 µH	1	TRN0204	SEN HUEI	L2
Transformer EI-22 900 μH	1	TRN0317	SEN HUEI	TX1
Schottky Diode 5 A / 40 V	1	SB540	FAIRCHILD	D1
Fast Diode 1 A / 1000 V	1	1N4007	FAIRCHILD	D2
Fast Diode 1 A / 200 V	1	1N4935	FAIRCHILD	D3
SMD Fast Diode 1 A / 1000 V	2	S1M	FAIRCHILD	D6, D7
Bridge 2 A / 800 V	1	2KBP08M	FAIRCHILD	BD1
REGULATOR KA431L ±0.5%	1		FAIRCHILD	U3
IC FOD817A DIP	1		FAIRCHILD	U2
FUSE CERAMIC 250 V 1 A 3.6*10 mm	1	SLOW 37SG	SLEEK	F1
Varistor 7ψ470 V	1			MOV
TVS Breakdown Voltage 143 V–158 V	1	P6KE150A	FAIRCHILD	D8
Test Pin SG004-05	4			L N VO+ VO-
PCB PLM0152 REV0	1		FAIRCHILD	
FSB127HNY	1		FAIRCHILD	U1





# 7. Transformer

# 7.1. Transformer Specification



Core: EI-22 (Ae=37.5 mm<sup>2</sup>) Bobbin: EI-22

#### Figure 21. Transformer Specification

#### Table 1. Winding Specifications

	Pins (S $\rightarrow$ F)	Wire	Turns	Winding Method			
N <sub>p</sub> /2	$3 \rightarrow 2$	0.27φ×1	31	Solenoid Winding			
Insulation	: Polyester Tape t =	= 0.025 mm, 3 Laye	er				
N <sub>5V</sub>	6  ightarrow 10	0.55φ×2	5	Solenoid Winding			
Insulation	: Polyester Tape t =	= 0.025 mm, 3 Laye	ers				
N <sub>p</sub> /2	$2 \rightarrow 1$	0.27φ×1	31	Solenoid Winding			
Insulation	Insulation: Polyester Tape t = 0.025 mm, 6 Layers						
Na	$4 \rightarrow 5$	0.15φ×1	12	Solenoid Winding			
Insulation	: Polyester Tape t =	= 0.025 mm, 3 Laye	ers				

#### Table 2. Specifications

	Pins	Specifications	Remark
Primary-Side Inductance	1 - 3	900 µH ±10%	100 kHz, 1 V
Primary-Side Effective Leakage	1 - 3	< 30 OH Max.	Short All Other Pins





# 8. Revision History

Rev.	Date	Description
1.0.0	11/10/11	Initial release
1.0.1	02/04/13	Modify description of test condition

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Replace components on the Evaluation Board only with those parts shown on the parts list (or Bill of Materials) in the Users' Guide. Contact an authorized Fairchild representative with any questions.

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